

M.2 2280 830 Datasheet

(SQF-SM8x-xxx-SAx)





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Revision History

Rev.	Date	History
0.1	2015/1/23	1. Preliminary
0.2	2015/4/2	Pin define correction
0.3	2015/5/15	Model name update
0.4	2015/8/15	Part number table update
0.5	2015/8/20	Capacity correction
0.6	2016/3/25	Update detail spec.
0.7	2016/5/25	Update SLC and Ultra MLC information

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SQFlash *M.2* 2280 830

1. Overview

Advantech SQFlash 830 series M.2 2280 (SQF-SM8 830) delivers all the advantages of flash disk technology with the Serial ATA I/II/III interface and is fully compliant with the standard Next Generation Form Factor (NGFF). The SQF-SM8 830 is designed to operate at a maximum operating frequency of 300MHz with 30MHz external crystal. Its capacity could provide a wide range up to 480GB. Moreover, it can reach up to 520MB/s read as well as 500MB/s write high performance based on Toggle 2.0 MLC flash (with 512MB DDR enabled and measured by CrystalDiskMark v3.0). The power consumption of SQF-SM8 830 is much lower than traditional hard drives, making it the best embedded solution for new platforms.



2. Features

Standard SATA interface

- Support SATA 1.5/3.0/6.0 Gbps interface
- SATA Revision 3.2 compliant
- Operating Voltage: 3.3V
- Support 120 bit ECC correct per 2K Byte data
- TRIM · AHCI supported
- AES256 and Hardware Quick Erase supported

■ Temperature Ranges

- Commercial Temperature
 - 0°C to 70°C for operating
 - -40 $^{\circ}$ C to 85 $^{\circ}$ C for storage
- Industrial Temperature
 - -40°C to 85°C for operating
 - -40°C to 85°C for storage

Mechanical Specification

Shock: 1,500G / 0.5ms

Vibration: 20G / 80~2,000Hz

Humidty

Humidity: 5% ~ 95% under 55°€

■ Endurance : > 2,000,000 program/erase cycles

This is a test result of the whole SQFlash drive. The test is to keep writing a fixed logical block address (LBA) and see if any bad blocks occur after 2M cycles. With wear-levelling mechanism, although the disk was kept writing the same LBA but the physical block changes per block writing. So this test also proves that wear-leveling is really working, or the block would be wearout after its designated life cycles.

■ Data Retention

- 10 years
- Acquired RoHS \ WHQL \ CE \ FCC Certificate

■ Acoustic : 0 dB

■ Dimension: 80.8 mm x 22.0 mm x 3.8 mm



3. Specification Table

■ Performance

		Sequential Performance (MB/sec)		Random Performance (IOPS @4K)	
		Read	Write	Read	Write
	32 GB	492.31	249.43	82,918	41,774
SLC	64 GB	503.50	466.40	87,173	73,533
	128 GB	505.00	462.30	87,094	71,985
	64 GB	561.30	449.70	96,479	66,952
Ultra	128 GB	562.10	535.50	96,968	88,548
MLC	256 GB	561.60	516.80	97,219	87,063
	512 GB	561.90	538.60	95,974	94,106
	64 GB	521.40	103.40	54,400	26,394
	128 GB	544.80	201.80	87,296	50,586
MLC	256 GB	543.40	399.20	89,062	93,235
	512 GB	545.50	392.70	88,755	91,341
	1 TB	541.40	482.80	88,038	91,699

^{*} All performance above are tested with AHCI mode.

Endurance

JEDEC defined an endurance rating TBW (TeraByte Written), following by the equation below, for indicating the number of terabytes a SSD can be written which is a measurement of SSDs' expected lifespan, represents the amount of data written to the device.

TBW = [(NAND Endurance) x (SSD Capacity)] / WAF

NAND Endurance: Program / Erase cycle of a NAND flash.

SLC: 100,000 cyclesUltra MLC: 30,000 cycles

o MLC: 3,000 cycles

• SSD Capacity: SSD physical capacity in total of a SSD.

• WAF: Write Amplification Factor (WAF), as the equation shown below, is a numerical value representing the ratio between the amount of data that a SSD controller needs to write and the amount of data that the host's flash controller writes. A better WAF, which is near to 1, guarantees better endurance and lower frequency of data written to flash memory.

WAF = (Lifetime write to flash) / (Lifetime write to host)

Endurance measurement is based on JDEC 219 workload and verified with following workload conditions,

- PreCond%full = 100%
- Trim commands enabled
- Random data pattern.

SQFlash 830 mSATA TBW

	WAF		TBW	
	VVAF	SLC	Ultra MLC	MLC
64 GB	1.4353	4354	1306	131
128 GB	1.4275	8757	2627	263
256 GB	1.4214		5276	528
512 GB	1.4198		10565	1056
1 TB	1.4137			2122

TBW consider with warranty period of time can also be presented by DWPD (Drive Write per Day) as below.

DWPD = TBW / SSD Capacity / Warranty Days (3 years *365)

SQFlash 830 mSATA DWPD

	Marranty		DWPD	
	Warranty	SLC	Ultra MLC	MLC
64 GB	3 years	63.63	19.09	1.91
128 GB	3 years	63.97	19.19	1.92
256 GB	3 years		19.27	1.93
512 GB	3 years		19.30	1.93
1 TB	3 years			1.94



SQFlash

4. **General Description**

■ Error Correction Code (ECC)

Flash memory cells will deteriorate with use, which might generate random bit errors in the stored data. Thus, SQFlash 830 series M.2 2280 SSD applies the BCH ECC algorithm, which can detect and correct errors occur during read process, ensure data been read correctly, as well as protect data from corruption.

Wear Leveling

NAND flash devices can only undergo a limited number of program/erase cycles, and in most cases, the flash media are not used evenly. If some areas get updated more frequently than others, the lifetime of the device would be reduced significantly. Thus, Wear Leveling is applied to extend the lifespan of NAND Flash by evenly distributing write and erase cycles across the media.

SQFlash provides advanced Wear Leveling algorithm, which can efficiently spread out the flash usage through the whole flash media area. Moreover, by implementing both dynamic and static Wear Leveling algorithms, the life expectancy of the NAND flash is greatly improved.

■ Bad Block Management

Bad blocks are blocks that include one or more invalid bits, and their reliability is not guaranteed. Blocks that are identified and marked as bad by the manufacturer are referred to as "Initial Bad Blocks". Bad blocks that are developed during the lifespan of the flash are named "Later Bad Blocks". SQFlash implements an efficient bad block management algorithm to detect the factory-produced bad blocks and manages any bad blocks that appear with use. This practice further prevents data being stored into bad blocks and improves the data reliability.

■ Power Loss Protection: Flush Manager

Power Loss Protection is a mechanism to prevent data loss during unexpected power failure. DRAM is a volatile memory and frequently used as temporary cache or buffer between the controller and the NAND flash to improve the SSD performance. However, one major concern of the DRAM is that it is not able to keep data during power failure. Accordingly, SQFlash SSD applies the Flush Manager technology, only when the data is fully committed to the NAND flash will the controller send acknowledgement (ACK) to the host. Such implementation can prevent false-positive performance and the risk of power cycling issues. In addition, it is critical for a controller to shorten the time the in-flight data stays in the controller internal cache. Thus, SQFlash applies an algorithm to reduce the amount of data resides in the cache to provide a better performance. With Flush Manager, incoming data would only have a "pit stop" in the cache and then move to NAND flash directly. Also, the onboard DDR will be treated as an "organizer" to consolidate incoming data into groups before written into the flash to improve write amplification.

■ TRIM

TRIM is a feature which helps improve the read/write performance and speed of solid-state drives (SSD). Unlike hard disk drives (HDD), SSDs are not able to overwrite existing data, so the available space gradually becomes smaller with each use. With the TRIM command, the operating system can inform the SSD which blocks of data are no longer in use and can be removed permanently. Thus, the SSD will perform the erase action, which prevents unused data from occupying blocks all the time.

■ SMART

SMART, an acronym for Self-Monitoring, Analysis and Reporting Technology, is an open standard that allows a hard disk drive to automatically detect its health and report potential failures. When a failure is recorded by SMART, users can choose to replace the drive to prevent unexpected outage or data loss. Moreover, SMART can inform users of impending failures while there is still time to perform proactive actions, such as copy data to another device.



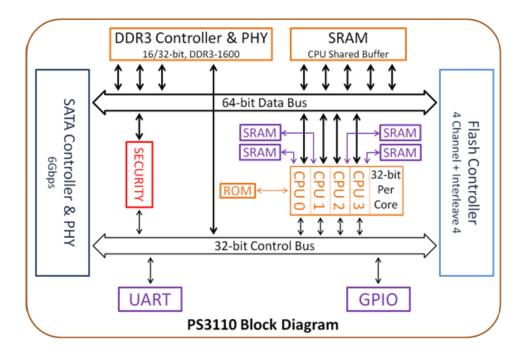
SQFlash
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Over-Provision

Over Provisioning refers to the inclusion of extra NAND capacity in a SSD, which is not visible and cannot be used by users. With Over Provisioning, the performance and IOPS (Input/Output Operations per Second) are improved by providing the controller additional space to manage P/E cycles, which enhances the reliability and endurance as well. Moreover, the write amplification of the SSD becomes lower when the controller writes data to the flash.



■ Block Diagram



■ LBA value

Density	LBA
32 GB	62,533,296
64 GB	125,045,424
128 GB	250,069,680
256 GB	500,118,192
512 GB	1,000,215,216
1 TB	2,000,409,264



5. Pin Assignment and Description

5.1 M.2 2280 Interface Pin Assignments

Pin #	SATA Pin	Description	
1	CONFIG_3 = GND	Ground	
2	3.3V	Supply pin	
3	GND	Ground	
4	3.3V	Supply pin	
5	N/C	No Connect	
6	N/C	No Connect	
7	N/C	No Connect	
8	N/C	No Connect	
9	N/C or GND Note	No Connect or Ground	
10	DAS/DSS# (O) (OD)	Status indicators via LED devices that will be provided by the system Active Low. A pulled-up LED with series current limiting resistor should allow for 9mA when On.	
11	N/C	No Connect	
12	Module Key		
13	Module Key		
14	Module Key		
15	Module Key		
16	Module Key		
17	Module Key		
18	Module Key		
19	Module Key		
20	N/C	No Connect	
21	CONFIG_0 = GND	Ground	
22	N/C	No Connect	
23	N/C	No Connect	
24	N/C	No Connect	
25	N/C	No Connect	
26	N/C	No Connect	
27	GND	Ground	
28	N/C	No Connect	
29	N/C	No Connect	
30	N/C	No Connect	
31	N/C	No Connect	
32	N/C	No Connect	
33	GND	Ground	
34	N/C	No Connect	
35	N/C	No Connect	

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36	N/C	No Connect
37	N/C	No Connect
38	DEVSLP (I) (0/3.3V)	Device Sleep, Input. When driven high the host is informing the SSD to enter a low power state (default NC, DEVSLP disable)
39	GND	Ground
40	N/C	No Connect
41	SATA-B+	SATA differential signals in the SATA specification
42	N/C	No Connect
43	SATA-B-	SATA differential signals in the SATA specification
44	N/C	No Connect
45	GND	Ground
46	N/C	No Connect
47	SATA-A-	SATA differential signals in the SATA specification
48	N/C	No Connect
49	SATA-A+	SATA differential signals in the SATA specification
50	N/C	No Connect
51	GND	Ground
52	N/C	No Connect
53	N/C	No Connect
54	N/C	No Connect
55	N/C	No Connect
56	Reserved for MFG Data	Manufacturing Data line. Used for SSD manufacturing only. Not used in normal operation. Pins should be left N/C in platform Socket.
57	GND	Ground
58	Reserved for MFG Clock	Manufacturing Clock line. Used for SSD manufacturing only. Not used in normal operation. Pins should be left N/C in platform Socket
59	Module Key	
60	Module Key	
61	Module Key	
62	Module Key	
63	Module Key	
64	Module Key	
65	Module Key	
66	Module Key	
67	N/C	No Connect
68	SUSCLK (I) (0/3.3V)	32 kHz clock supply input that is provided by PCH to reduce power and cost for the module. (default NC)
69	CONFIG_1 = GND	Defines module type
70	3.3V	Supply pin
71	GND	Ground

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72	3.3V	Supply pin
73	GND	Ground
74	3.3V	Supply pin
75	CONFIG_2 = GND	Ground

NOTE: N/C for Socket 2, and GND for Socket 3.



6. Identify Device Data

The Identity Device Data enables Host to receive parameter information from the device. The parameter words in the buffer have the arrangement and meanings defined in below table. All reserve bits or words are zero

Word	ATA Identify Parameter	Value
0	General configuration	0040h
1	Number of cylinders in the default CHS translation	3FFFh
2	Specific configuration	C837h
3	Number of heads in the default CHS translation	0010h
4-5	Retired	0000h
6	Number of sectors per track in the default CHS translation	003Fh
7-8	Reserved for the CFA	0000h
9	Obsolete	0000h
10-19	Serial number	ASCII
20	Retired	0000h
21	Retired	0000h
22	Obsolete	0000h
23-26	Firmware revision	ASCII
27-46	Model number	ASCII
47	READ/WRITE MULTIPLE commands function	8010h
48	Trusted Computing feature set options	4000h
49	Capabilities	2F00h
50	Capabilities	4000h
51-52	Obsolete	0000h
53	field validity	0007h
54	Number of cylinders in the current CHS translation	3FFFh
55	Number of heads in the current CHS translation	0010h
56	Number of sectors per track in the current CHS translation	003Fh
57-58	Current capacity in sectors	00FBFC10h
59	Multiple sector setting	0110h
60-61	Total number of user addressable logical sectors for 28-bit commands	*3
62	Obsolete	0000h
63	Multiword DMA modes	0407h
64	PIO mode supported	0003h
65	Minimum Multiword DMA transfer cycle time per word	0078h
66	Manufacturer's recommended Multiword DMA transfer cycle time	0078h
67	Minimum PIO transfer cycle time without flow control	0078h
68	Minimum PIO transfer cycle time with IORDY flow control	0078h
69	Additional Supported	5F20h
70-73	Reserved	0000h
74	Reserved	0000h
75	Queue depth	001Fh
76	Serial ATA Capabilities	E70Eh
77	Supported Serial ATA Phy speed	0006/0004/0002h
78	Serial ATA features supported	054Ch



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79	Serial ATA features enabled	0040h
	Major version number	03F8h
	Minor version number	0000h
	Commands and feature sets supported	746Bh
	Commands and feature sets supported	7D09h
	Commands and feature sets supported	4163h
	Commands and feature sets supported or enabled	7469h
	Commands and feature sets supported or enabled	BC09h
	Commands and feature sets supported or enabled	4163h
	Ultra DMA modes	007Fh
		007FII
90	Time required for Normal Erase mode SECURITY ERASE UNIT command Time required for an Enhanced Erase mode SECURITY ERASE UNIT command	0001h
91	Current APM level value	00FEh
	Master Password Identifier	FFFEh
	Hardware reset result	0000h
	Current AAM value	0000h
	Stream Minimum Request Size	0000h
	Streaming Transfer Time - DMA	0000h
	Streaming Access Latency -DMA and PIO	0000h
	Streaming Performance Granularity	0000h
	Total Number of User Addressable Logical Sectors for 48-bit commands	*4
	-	0000h
	Streaming Transfer Time - PIO Maximum number of 512-byte blocks of LBA Range Entries per DATA	000011
105	SET MANAGEMENT command	0008h
	Physical sector size / logical sector size	4000h
	Inter-seek delay for ISO 7999 standard acoustic testing	0000h
	World wide name	Vender Specific
	Reserved	0000h
	Reserved for TLC	0000h
	Logical sector size	0000h
	Commands and feature sets supported	401Ch
	Commands and feature sets supported or enabled	401Ch
	Reserved for expanded supported and enabled settings	0000h
125-126	Reserved for expanded supported and enabled settings	0000h
127	Obsolete	0000h
128	Security status	0021h
129-159	Vendor specific	0000h
160	CFA power mode	0000h
161-164	Reserved for the CFA	0000h
165-167	Reserved for the CFA	0000h
168	Device Nominal Form Factor	0003h
169	DATA SET MANAGEMENT is supported	0001h
170-173	Additional Product Identifier	0000h
174-175	Reserved	0000h
176-205	Current media serial number	0000h
	SCT Command Transport	0039h

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207-208	Reserved for CE-ATA	0000h
209	Alignment of logical blocks within a physical block	4000h
210-211	Write-Read-Verify Sector Count Mode 3	0000h
212-213	Write-Read-Verify Sector Count Mode 2	0000h
214	NV Cache Capabilities	0000h
215-216	NV Cache Size in Logical Blocks	0000h
217	Nominal media rotation rate	0001h
218	Reserved	0000h
219	NV Cache Options	0000h
220	Current mode of the Write-Read-Verify feature set	0000h
221	Reserved	0000h
222	Transport major version number	107Fh
223	Transport minor version number	0000h
224-227	Reversed for CE-ATA	0000h
228-229	Reversed for CE-ATA	0000h
230-233	Extend Number of User Addressable Sectors	0000h
234	Minimum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h	0001h
235	Maximum number of 512-byte data blocks per DOWNLOAD MICROCODE command for mode 03h	FFFFh
236-239	Reserved	0000h
	Reserved	0000h
243	Security feature 4000 : Self Encrypting Drive	4000h
244-247	Reserved	0000h
248-251	Reserved	0000h
252-254	Reserved	0000h
255	Integrity word	xxA5h

Capacity	*1	*2	*3	*4
(GB)	(Word 1/Word 54)	(Word 57 – 58)	(Word 60 – 61)	(Word 100 – 103)
60				
120	3FFFh	FBFC10h	DF94BB0h	DF94BB0h
240	3FFFh	FBFC10h	FFFFFFFh	1BF244B0h
480	3FFFh	FBFC10h	FFFFFFFh	37E436B0h



7. <u>ATA Command Set</u> [Command Set List]

Op-Code	Op-Code Command Description		p-Code	Command Description	
00h	NOP	60h		Read FPDMA Queued	
06h	Data Set Management	61h		Write FPDMA Queued	
10h	Recalibrate	70h		Seek	
20h	Read Sectors	90h		Execute Device Diagnostic	
21h	Read Sectors without Retry	91h		Initialize Device Parameters	
24h	Read Sectors EXT	92h		Download Microcode	
25h	Read DMA EXT	93h		Download Microcode DMA	
27h	Read Native Max Address EXT	B0h		SMART	
29h	Read Multiple EXT	B0h	D0h	SMART READ DATA	
2Fh	Read Log EXT	B0h	D1h	SMART READ DATA ATTRIBUTE THRESHOLD	
30h	Write Sectors	B0h	D2h	SMART ENABLE/DISABLE ATTRIBUTE AUTOSAVE	
31h	Write Sectors without Retry	B0h	D3h	SMART SAVE ATTRIBUTE VALUES	
34h	Write Sectors EXT	B0h	D4h	SMART EXECUTE OFF-LINE IMMEDIATE	
35h	Write DMA EXT	B0h	D5h	SMART READ LOG	
37h	Set Native Max Address EXT	B0h	D6h	SMART WRITE LOG	
39h	Write Multiple EXT	B0h	D8h	SMART ENABLE OPERATIONS	
3Dh	Write DMA FUA EXT	B0h	D9h	SMART DISABLE OPERATIONS	
3Fh	Write Long EXT	B0h	DAh	SMART RETURN STATUS	
40h	Read Verify Sectors	B0h	DBh	SMART ENABLE/DISABLE AUTOMATIC OFF-LINE	
41h	Read Verify Sectors without Retry	B1h	·	DEVICE CONFIGURATION OVERLAY	
42h	Read Verify Sectors EXT	B1h	C0h	DEVICE CONFIGURATION RESTORE	
45h	Write Uncorrectable EXT	B1h	C1h	DEVICE CONFIGURATION FREEZE LOCK	
47h	Read Log DMA EXT	B1h	C2h	DEVICE CONFIGURATION IDENTIFY	
57h	Write Log DMA EXT	B1h	C3h	DEVICE CONFIGURATION SET	
B1h C4h	DEVICE CONFIGURATION IDENTIFY DMA	ECh		Identify Device	
B1h C5h	DEVICE CONFIGURATION SET DMA	EFh		Set Features	
C4h	Read Multiple	EFh	02h	Enable 8-bit PIO transfer mode	
				1	

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C5h	Write Multiple	EFh	03h		Set transfer mode based on value in Count field	
C6h	Set Multiple Mode	EFh	05h		Enable advanced power management	
C8h	Read DMA	EFh	10h		Enable use of Serial ATA feature	
C9h	Read DMA without Retry	EFh	10h	02h	Enable DMA Setup FIS Auto-Activate optimization	
CAh	Write DMA	EFh	10h	03h	Enable Device-initiated interface power state (DIPM) transitions	
CBh	Write DMA without Retry	EFh	10h	06h	Enable Software Settings Preservation (SSP)	
CEh	Write Multiple FUA EXT	EFh	10h	07h	Enable Device Automatic Partial to Slumber transitions	
E0h	Standby Immediate	EFh	10h	09h	Enable Device Sleep	
E1h	Idle Immediate	EFh	55h		Disable read look-ahead feature	
E2h	Standby	EFh	66h		Disable reverting to power-on defaults	
E3h	Idle	EFh	82h		Disable write cache	
E4h	Read Buffer	EFh	85h		Disable advanced power management	
E5h	Check Power Mode	EFh	90h		Disable use of Serial ATA feature set	
E6h	Sleep	EFh	90h	02h	Disable DMA Setup FIS Auto-Activate optimization	
E7h	Flush Cache	EFh	90h	03h	Disable Device-initiated interface power state (DIPM) transitions	
E8h	Write Buffer	EFh	90h	06h	Disable Software Settings Preservation (SSP)	
E9h	Read Buffer DMA	EFh	90h	07h	Disable Device Automatic Partial to Slumber transitions	
EAh	Flush Cache EXT	EFh	90h	09h	Disable Device Sleep	
EBh	Write Buffer DMA	EFh	AAh		Enable read look-ahead feature	
EFh	CCh	Enable reverting to power-on defaults	F4h		Security Erase Unit	
F1h	Security Set Password	F5h	- 5		Security Freeze Lock	
F2h	Security Unlock	F6h			Security Disable Password	
F3h	Security Erase Prepare	F8h	F		Read Native Max Address	

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Note: ND = Non-Data Command
PI = PIO Data-In Command
PO = PIO Data-Out Command
DM = DMA Command

DD = Execute Diagnostic Command

[Command Set Descriptions]

1. CHECK POWER MODE (code: E5h);

This command allow host to determine the current power mode of the device.

2. DOWNLOAD MICROCODE (code: 92h);

This command enable the host to alter the device's microcode. The data transferred using the DOWNLOAD MICROCODE command is vendor specific.

All transfers shall be an integer multiple of the sector size. The size of the data transfer is determined by the content of the LBA Low register and the Sector Count register.

This allows transfer sizes from 0 bytes to 33,553,920 bytes, in 512bytes increments.

3. EXECUTE DEVICE DIAGNOSTIC (code: 90h);

This command performs the internal diagnostic tests implemented by the module.

4. FLUSH CACHE (code: E7h);

This command used by the host to request the device to flush the write cache.

5. FLUSH CACHE EXT (code: EAh);

This command is used by the host to request the device to flush the write cache. If there is data in the write cache, that data shall be written to the media.

6. IDENTIFY DEVICE (code: ECh);

The IDENTIFY DEVICE command enables the host to receive parameter information from the module.

7. IDLE (code: 97h or E3h);

This command allows the host to place the module in the IDLE mode and also set the Standby timer. INTRQ may be asserted even through the module may not have fully transitioned to IDLE mode. If the Sector Count register is non-"0", then the Standby timer shall be enabled. The value in the Sector Count register shall be used to determine the time programmed into the Standby timer. If the Sector Count register is "0" then the Standby timer is disabled.

8. IDLE IMMEDIATE (code: E1h);

This command causes the module to set BSY, enter the Idle (Read) mode, clear BSY and generate an interrupt.

9. INITIALIZE DEVICE PARAMETERS (code: 91h);

This command enables the host to set the number of sectors per track and the number of heads per cylinder.

10. NOP (code: 00h);

If this command is issued, the module respond with command aborted.

11. READ BUFFER (code: E4h);

This command enables the host to read the current contents of the module's sector buffer.

12. READ DMA (code: C8h or C9h);

This command reads from "1" to "256" sectors as specified in the Sector Count register using the DMA

data transfer protocol. A sector count of "0" requests "256" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

13. READ DMA Ext (code: 25h);

This command allows the host to read data using the DMA data transfer protocol.

14. READ MULTIPLE (code: C4h);

This command performs similarly to the READ SECTORS command. Interrupts are not generated on each sector, but on the transfer of a block which contains the number of sector per block is defined by the content of word 59 in the IDENTIFY DEVICE response.

15. READ MULTIPLE EXT (code: 29h);

This command performs similarly to the READ SECTORS command. The number of sectors per block is defined by a successful SET MULTIPLE command. If no successful SET MULTIPLE command has been issued, the block is defined by the device's default value for number of sectors per block as defined in bits (7:0) in word 47 in the IDENTIFY DEVICE information.

16. READ NATIVE MAX ADDRESS (code: F8h);

This command returns the native maximum address. The native maximum address is the highest address accepted by the device in the factory default condition.

17. READ NATIVE MAX ADDRESS EXT (code: 27h);

This command returns the native maximum address.

18. READ SECTOR(S) (code: 20h or 21h);

This command reads from "1" to "256" sectors as specified in the Sector Count register. A sector count of "0" requests "256" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

19. READ SECTOR(S) EXT (code: 24h);

This command reads from "1" to "65536" sectors as specified in the Sector Count register. A sector count of "0" requests "65536" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

20. READ VERIFY SECTOR(S) (code: 40h or 41h);

This command is identical to the READ SECTORS command, except that DRQ is never set and no data is transferred to the host.

21. READ VERIFY SECTOR(S) EXT (code: 42h);

This command is identical to the READ SECTORS command, except that DRQ is never set and no data is transferred to the host.

22. RECALIBRATE (code: 1Xh);

This command return value is select address mode by the host request.

23. SECURITY DISABLE PASSWORD (code: F6h);

This command transfers 512 bytes of data from the host. Table defines the content of this information. If the password selected by word 0 match the password previously saved by the device, the device shall disable the Lock mode. This command shall not change the Master password. The Master password shall be reactivated when a User password is set.

24. SECURITY ERASE PREPARE (code: F3h);

This command shall be issued immediately before the SECURITY ERASE UNIT command to enable device eraseing and unlocking.



25. SECURITY ERASE UNIT (code: F4h);

This command transfer 512 bytes of data from the host. Table## defines the content of this information. If the password does not match the password previously saved by the device, the device shall reject the command with command aborted.

The SECURITY ERASE PREPARE command shall be completed immediately prior to the SECURITY ERASE UNIT command.

26. SECURITY FREEZE LOCK (code: F5h);

This command shall set the device to frozen mode. After command completion any other commands that update the device Lock mode shall be command aborted. Frozen shall be disabled by power-off or hardware reset.

If SECURITY FREEZE LOCK is issued when the drive is in frozen mode, the drive executes the command and remains in frozen mode.

27. SECURITY SET PASSWORD (code: F1h);

This command transfer 512 bytes of data from the host. Table defines the content of this information. The data transferred controls the function of this command. Table defines the interaction of the identifier and security level bits.

28. SECURITY UNLOCK (code: F2h);

This command transfer 512 bytes of data from the host. Table (as Disable Password) defines the content of this information.

If the Identifier bit is set to Master and the device is in high security level, then the password supplied shall be compared with the stored Master password. If the device is in maximum security level then the unlock shall be rejected.

If the identifier bit is set to user then the device shall compare the supplied password with the stored User password.

If the password compare fails then the device shall return command aborted to the host and decrements the unlock counter. This counter shall be initially set to five and shall be decremented for each password mismatch when SECURITY UNLOCK is issued and the device is locked. When this counter reachs zero then SECURITY UNLOCK and SECURITY ERASE UNIT command shall be aborted unitl a power-on or a hardware reset.

29. SEEK (code: 7Xh);

This command performs address range check.

30. SET MAX ADDRESS (code: F9h);

After successful command completion, all read and write access attempts to address greater than specified by the successful SET MAX ADDRESS command shall be rejected with an IDNF error. IDENTIFY DEVICE response words (61:60) shall reflect the maximum address set with this command.

31. SET MAX ADDRESS EXT (code: 37h);

After successful command completion, all read and write access attempts to address greater than specified by the successful SET MAX ADDRESS command shall be rejected with an IDNF error. IDENTIFY DEVICE response words (61:60) shall reflect the maximum address set with this command.

32. SET FEATURE (code: EFh);

This command is used by the host to establish parameters that affect the execution of certain device features.

33. SET MULTIPLE MODE (code: C6h);

This command enables the device to perform READ and Write Multiple operations and establishes the block count for these commands.

34. SLEEP (code: 99h or E6h);



This command causes the module to set BSY, enter the Sleep mode, clear BSY and generate an interrupt.

35. SMART READ DATA (code: B0h with Feature register value of D0h);

This command returns the Device SMART data structure to the host.

36. SMART ENABLE/DISABLE AUTO SAVE (code: B0h with Feature register value of D2h);

This command enables and disables the optional attribute autosave feature of the device.

SMART EXECUTE OFF_LINE (code: B0h with Feature register value of D4h);

This command cause the device to immediately initiate the optional set of activities that collect SMART data in an off-line mode and then save this data to the device's non-volatile memory, or execute a self-diagnostic test routine in either captive or off-line mode.

38. SMART READ LOG (code: B0h with Feature register value of D5h);

This command returns the specified log data to the host.

39. SMART ENABLE OPERATION (code: B0h with Feature register value of D8h);

This command enables access to all SMART capabilities within the device. Prior to receipt of this command SMART data are neither monitored nor saved by the device.

40. SMART DISABLE OPERATION (code: B0h with Feature register value of D9h);

This command disables all SMART capabilities within the device including any and all timer and event count functions related exclusively to this feature. After command acceptance the device shall disable all SMART operations.

After receipt of this command by the device, all other SMART commands including SMART DISABLE OPERATION commands, with exception of SMART ENABLE OPERATIONS, are disabled and invalid and shall be command aborted by the device.

41. SMART RETURN STATUS (code: B0h with Feature register value of DAh);

This command cause the device to communicate the reliability status of the device to the host.

42. STANDBY (code: E2h);

This command causes the module to set BSY, enter the Standby mode, clear BSY and return the interrupt immediately.

43. STANDBY IMMEDIATE (code: E0h);

This command causes the module to set BSY, enter the Standby mode, clear BSY and return the interrupt immediately.

44. WRITE BUFFER (code: E8h);

This command enables the host to overwrite contents of the module's sector buffer with any data pattern desired.

45. WRITR DMA (code: CAh or CBh);

This command writes from "1" to "256" sectors as specified in the Sector Count register using the DMA data transfer protocol. A sector count of "0" requests "256" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

46. WRITR DMA EXT (code: 35h);

This command writes from "1" to "65536" sectors as specified in the Sector Count register using the DMA data transfer protocol. A sector count of "0" requests "65536" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

47. WRITE MULTIPLE (code: C5h);



SQFlash

This command is similar to the WRITE SECTORS command. Interrupts are not presented on each sector, but on the transfer of a block which contains the number of sectors defined by Set Multiple command.

48. WRITE MULTIPLE EXT (code: 39h);

This command is similar to the WRITE SECTORS command. Interrupts are not presented on each sector, but on the transfer of a block which contains the number of sectors defined by Set Multiple command.

49. WRITE SECTOR(S) (code: 30h);

This command writes from "1" to "256" sectors as specified in the Sector Count register. A sector count of "0" requests "256" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

50. WRITE SECTOR(S) EXT (code: 34h);

This command writes from "1" to "65536" sectors as specified in the Sector Count register. A sector count of "0" requests "65536" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

51. WRITE SECTOR(S) W/O ERASE (code: 38h);

This command writes from "1" to "256" sectors as specified in the Sector Count register. A sector count of "0" requests "256" sectors transfer. The transfer begins at the sector specified in the Sector Number register.

52. WRITE VERIFY (code: 3Ch);

This command is similar to the WRITE SECTOR(S) command, except that each sector is verified before the command is completed.



8. System Power Consumption

8.1 Supply Voltage

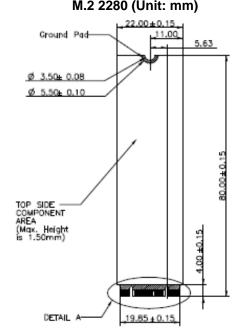
Parameter	Rating
Operating Voltage	3.3V

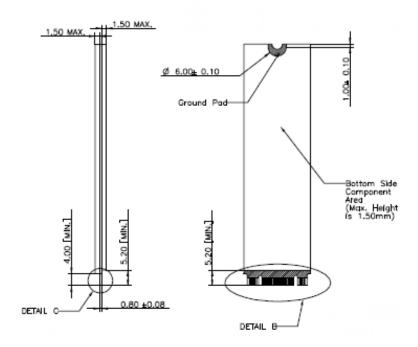
8.2 Power Consumption

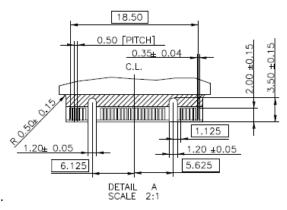
	mA	Read	Write	ldle	Slumber
SLC	32 GB	TBD	TBD	TBD	TBD
	64 GB	621.21	621.21	110.61	78.79
	128 GB	624.24	712.12	112.12	80.23
	64 GB	651.52	721.21	112.12	81.82
Ultra	128 GB	663.64	1,036.36	121.21	90.91
MLC	256 GB	690.91	1,251.52	122.73	90.91
	512 GB	765.20	1,260.31	202.00	197.00
	64 GB	621.21	621.21	110.61	78.79
MLC	128 GB	624.24	712.12	112.12	80.23
	256 GB	636.36	1,078.79	112.12	80.30
	512 GB	727.27	1,106.06	118.18	84.85
	1 TB	765.20	1,260.31	202.00	197.00

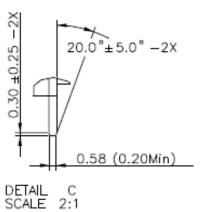


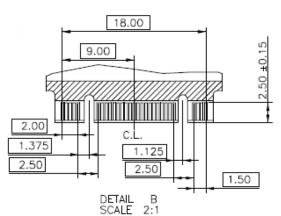
9. Physical Dimension M.2 2280 (Unit: mm)













Appendix: Part Number Table

Product	Advantech PN
SQF M2 2280 830 32G SLC (0~70°C)	SQF-SM8S8-32G-SAC
SQF M2 2280 830 64G SLC (0~70°C)	SQF-SM8S8-64G-SAC
SQF M2 2280 830 128G SLC (0~70°C)	SQF-SM8S8-128G-SAC
SQF M2 2280 830 64G UMLC (0~70°C)	SQF-SM8U8-64G-SAC
SQF M2 2280 830 128G UMLC (0~70°C)	SQF-SM8U8-128G-SAC
SQF M2 2280 830 256G UMLC (0~70°C)	SQF-SM8U8-256G-SAC
SQF M2 2280 830 512G UMLC (0~70°C)	SQF-SM8U8-512G-SAC
SQF M2 2280 830 64G MLC (0~70°C)	SQF-SM8M4-64G-SAC
SQF M2 2280 830 128G MLC (0~70°C)	SQF-SM8M8-128G-SAC
SQF M2 2280 830 256G MLC (0~70°C)	SQF-SM8M8-256G-SAC
SQF M2 2280 830 512G MLC (0~70°C)	SQF-SM8M8-512G-SAC
SQF M2 2280 830 1T MLC (0~70°C)	SQF-SM8M8-1T-SAC